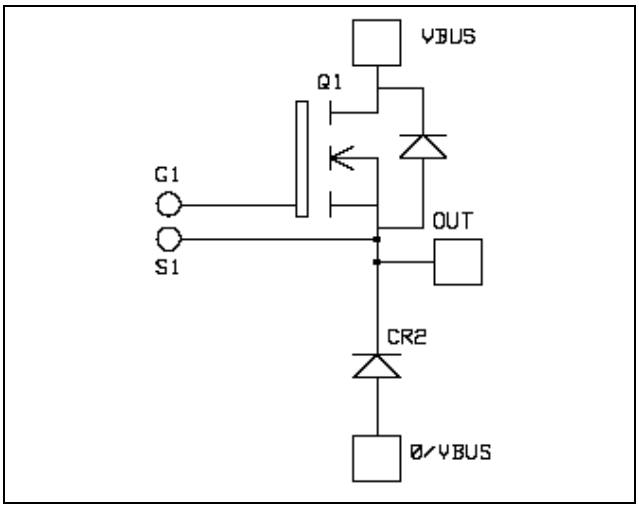
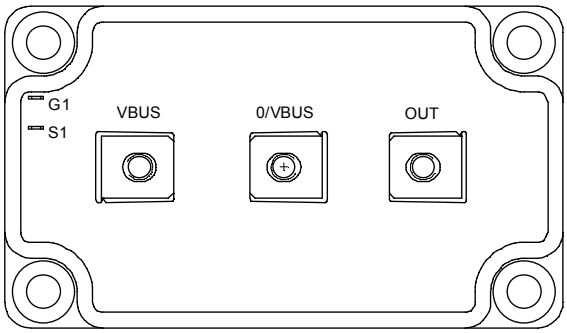
Buck chopper MOSFET Power Module

V_{DSS} = 500V
R_{DSon} = 19mΩ max @ Tj = 25°C
I_D = 163A @ Tc = 25°C





Application

- AC and DC motor control
- Switched Mode Power Supplies

Features

- Power MOS 7® MOSFETs
  - Low R_{DSon}
  - Low input and Miller capacitance
  - Low gate charge
  - Avalanche energy rated
  - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
  - Symmetrical design
  - M5 power connectors
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Low profile

Absolute maximum ratings

Symbol	*Parameter*		*Max ratings*	*Unit*
V_{DSS}	Drain - Source Breakdown Voltage		500	V
I_D	Continuous Drain Current	T_c = 25°C	163	A
		T_c = 80°C	122	
I_{DM}	Pulsed Drain current		652	
V_{GS}	Gate - Source Voltage		±30	V
R_{DSon}	Drain - Source ON Resistance		19	mΩ
P_D	Maximum Power Dissipation	T_c = 25°C	1136	W
I_{AR}	Avalanche current (repetitive and non repetitive)		46	A
E_{AR}	Repetitive Avalanche Energy		50	mJ
E_{AS}	Single Pulse Avalanche Energy		2500	

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handing Procedures Should Be Followed.

All ratings @ T_j = 25°C unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
BV_{DSS}	Drain - Source Breakdown Voltage	V_{GS} = 0V, I_D = 500µA		500			V
I_{DSS}	Zero Gate Voltage Drain Current	V_{GS} = 0V, V_{DS} = 500V	T_j = 25°C			200	µA
		V_{GS} = 0V, V_{DS} = 400V	T_j = 125°C			1000	
$R_{DS(on)}$	Drain – Source on Resistance	V_{GS} = 10V, I_D = 81.5A				19	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 10mA		3		5	V
I_{GSS}	Gate – Source Leakage Current	V_{GS} = ±30 V, V_{DS} = 0V				±200	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
C_{iss}	Input Capacitance	V_{GS} = 0V V_{DS} = 25V f = 1MHz		22.4		nF
C_{oss}	Output Capacitance			4.8		
C_{rss}	Reverse Transfer Capacitance			0.36		
Q_g	Total gate Charge	V_{GS} = 10V V_{Bus} = 250V I_D = 163A		492		nC
Q_{gs}	Gate – Source Charge			132		
Q_{gd}	Gate – Drain Charge			260		
$T_{d(on)}$	Turn-on Delay Time	**Inductive switching @ 125°C** V_{GS} = 15V V_{Bus} = 333V I_D = 163A R_G = 1Ω		18		ns
T_r	Rise Time			35		
$T_{d(off)}$	Turn-off Delay Time			87		
T_f	Fall Time			77		
E_{on}	Turn-on Switching Energy ❶	**Inductive switching @ 25°C** V_{GS} = 15V, V_{Bus} = 333V I_D = 163A, R_G = 1Ω		3020		µJ
E_{off}	Turn-off Switching Energy ❷			2904		
E_{on}	Turn-on Switching Energy ❶	**Inductive switching @ 125°C** V_{GS} = 15V, V_{Bus} = 333V I_D = 163A, R_G = 1Ω		4964		µJ
E_{off}	Turn-off Switching Energy ❷			3384		

Diode ratings and characteristics

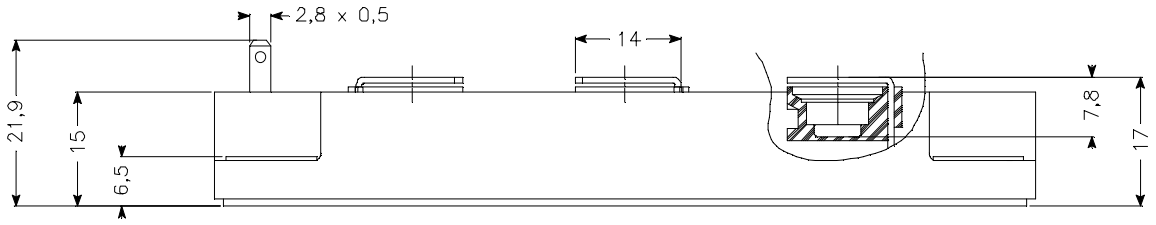
Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$I_{F(AV)}$	Maximum Average Forward Current	50% duty cycle	T_c = 70°C		120		A
V_F	Diode Forward Voltage	I_F = 120A			1.6	1.8	V
		I_F = 240A			1.9		
		I_F = 120A	T_j = 125°C		1.4		
t_{rr}	Reverse Recovery Time	I_F = 120A V_R = 400V di/dt = 400A/µs	T_j = 25°C		130		ns
			T_j = 125°C		170		
Q_{rr}	Reverse Recovery Charge	I_F = 120A V_R = 400V di/dt = 400A/µs	T_j = 25°C		440		nC
			T_j = 125°C		1840		

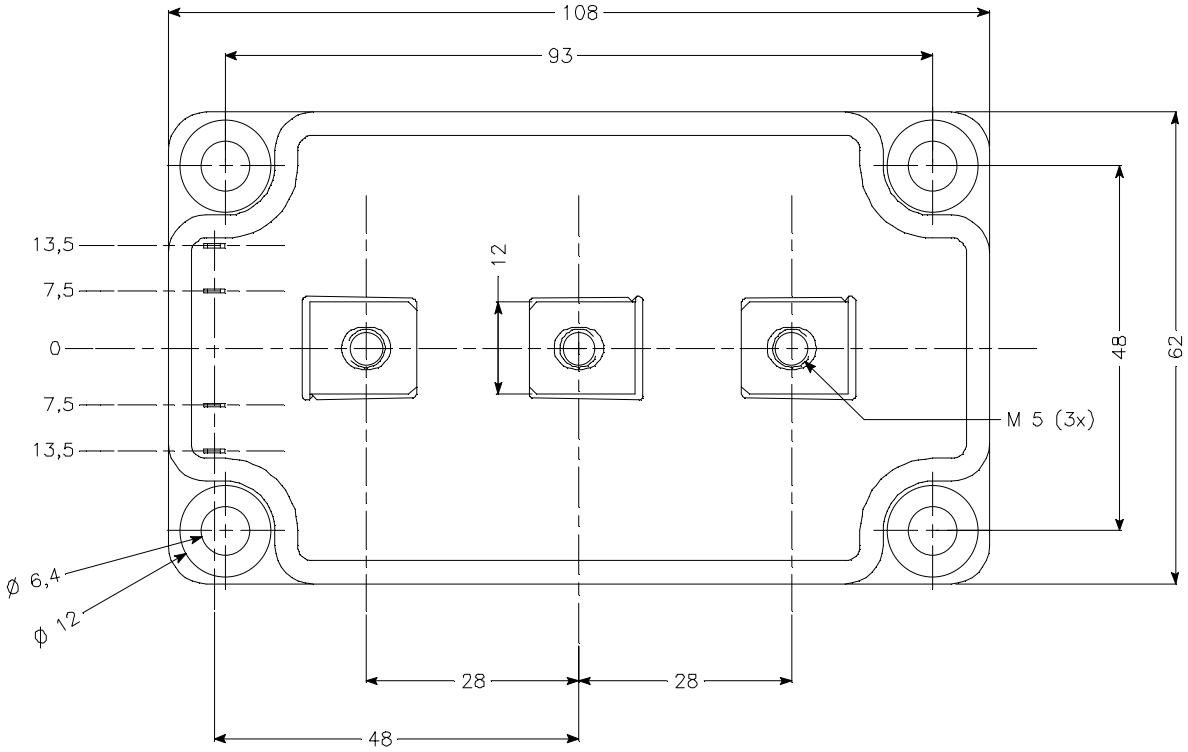
❶ E_{on} includes diode reverse recovery.
❷ In accordance with JEDEC standard JESD24-1.

Thermal and package characteristics

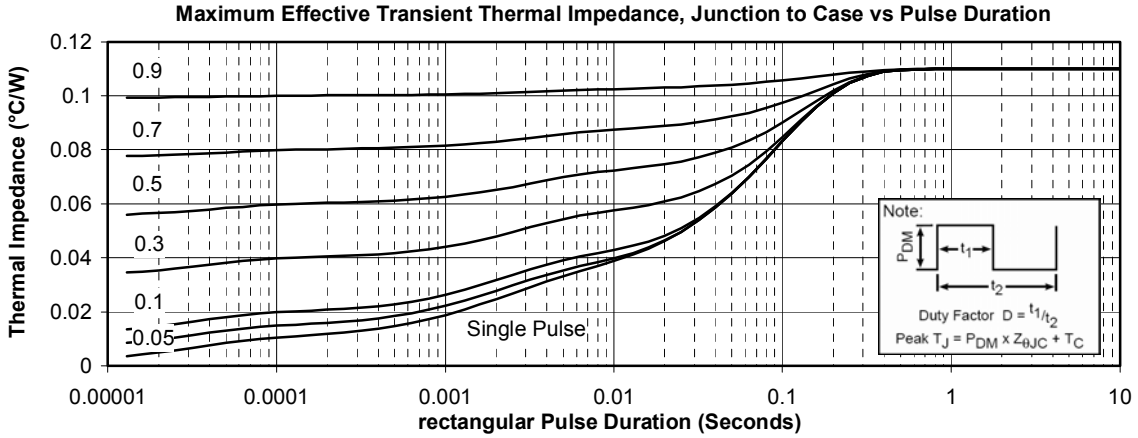
Symbol	Characteristic			Min	Typ	Max	Unit
R_{thJC}	Junction to Case		Transistor			0.11	°C/W
			Diode			0.46	
V_{ISOL}	RMS Isolation Voltage, any terminal to case t =1 min, I isol<1mA, 50/60Hz			2500			V
T_J	Operating junction temperature range			-40		150	°C
T_{STG}	Storage Temperature Range			-40		125	
T_C	Operating Case Temperature			-40		100	
Torque	Mounting torque	To heatsink	M6	3		5	N.m
		For terminals	M5	2		3.5	
Wt	Package Weight					280	g

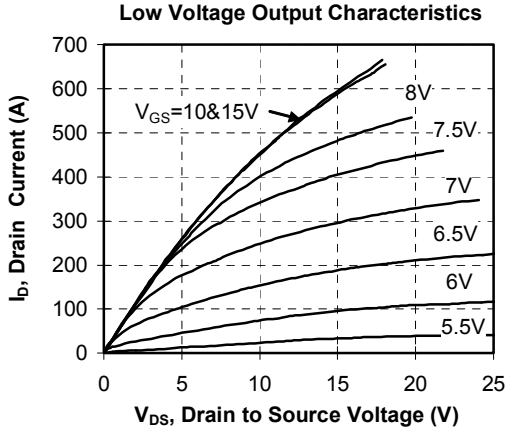
Package outline

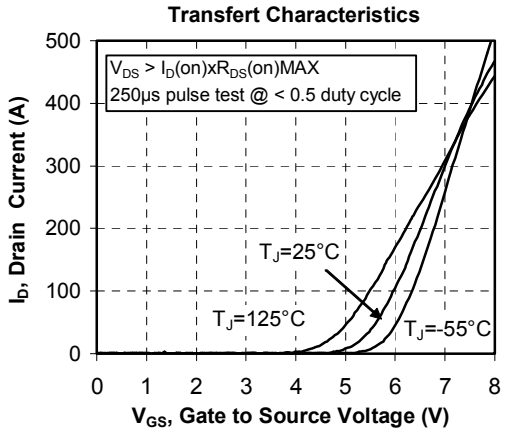


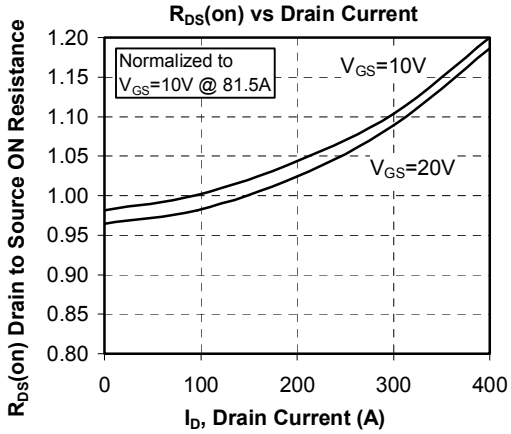


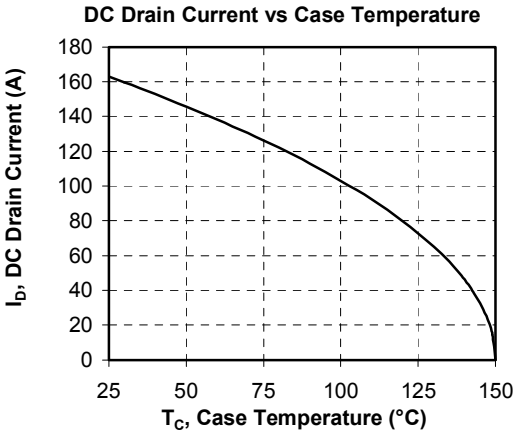
Typical Performance Curve

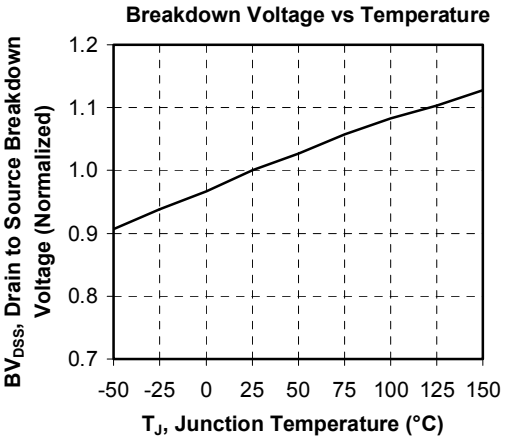


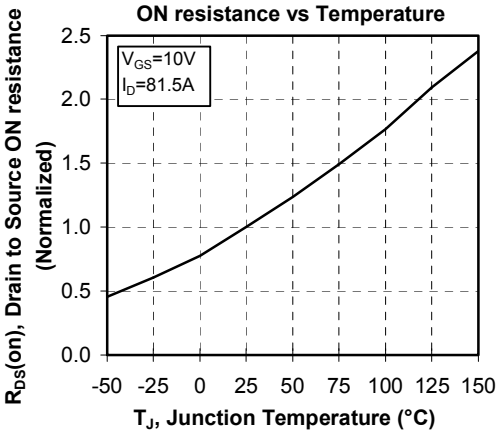


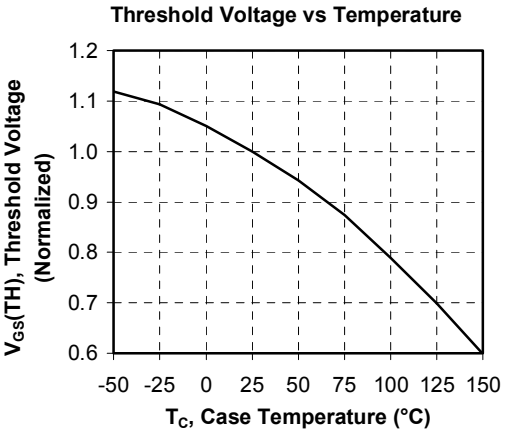


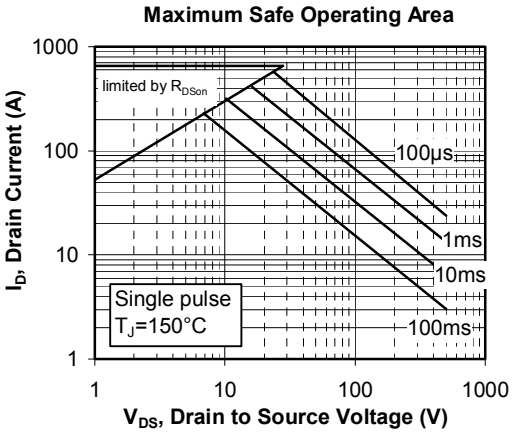


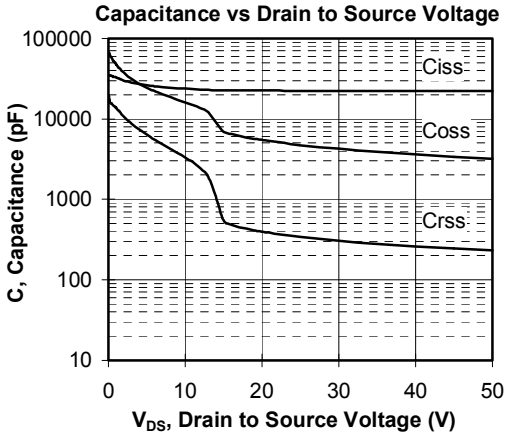


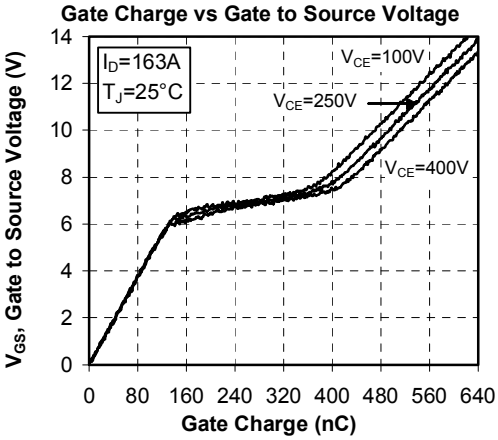

Breakdown Voltage vs Temperature
BVDSS, Drain to Source Breakdown Voltage (Normalized)
1.2
1.1
1.0
0.9
0.8
0.7
-50 -25 0 25 50 75 100 125 150
TJ, Junction Temperature (°C)

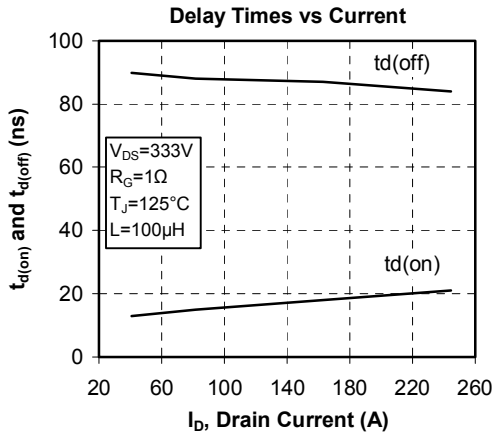

ON resistance vs Temperature
VGS=10V
ID=81.5A
RDS(on), Drain to Source ON resistance (Normalized)
2.5
2.0
1.5
1.0
0.5
0.0
-50 -25 0 25 50 75 100 125 150
TJ, Junction Temperature (°C)

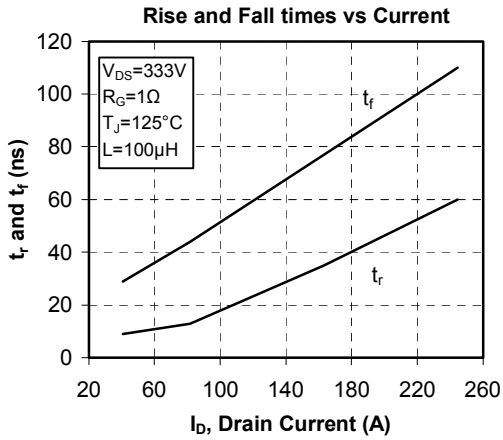

Threshold Voltage vs Temperature
VGS(TH), Threshold Voltage (Normalized)
1.2
1.1
1.0
0.9
0.8
0.7
0.6
-50 -25 0 25 50 75 100 125 150
TC, Case Temperature (°C)

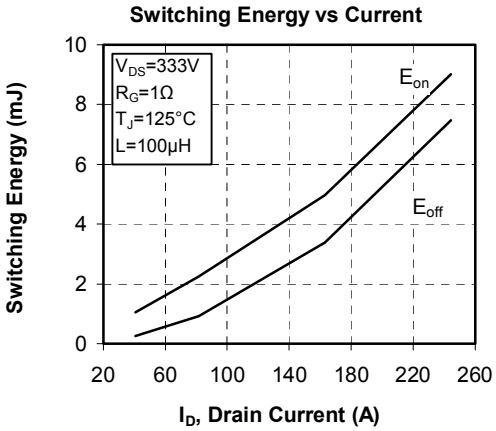

Maximum Safe Operating Area
ID, Drain Current (A)
1000
100
10
1
limited by RDSon
100µs
1ms
10ms
100ms
Single pulse
TJ=150°C
1 10 100 1000
VDS, Drain to Source Voltage (V)

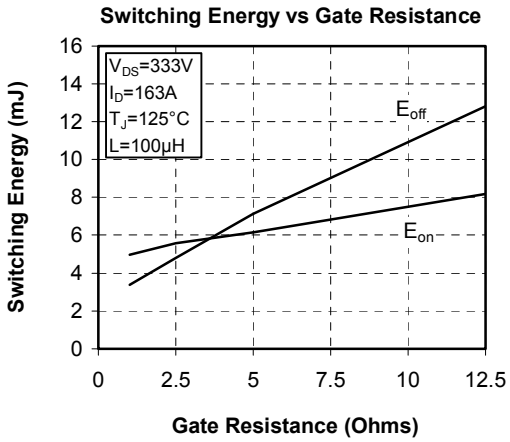

Capacitance vs Drain to Source Voltage
C, Capacitance (pF)
100000
10000
1000
100
10
Ciss
Coss
Crss
0 10 20 30 40 50
VDS, Drain to Source Voltage (V)

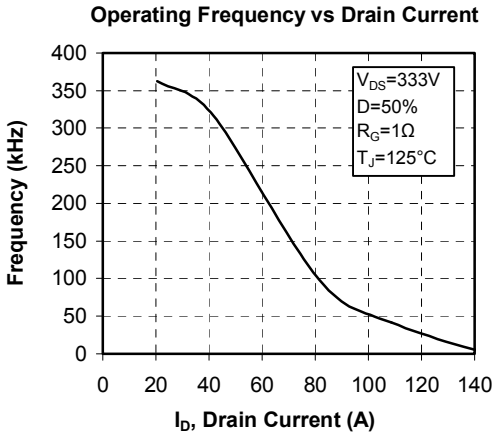

Gate Charge vs Gate to Source Voltage
ID=163A
TJ=25°C
VCE=100V
VCE=250V
VCE=400V
VGS, Gate to Source Voltage (V)
14
12
10
8
6
4
2
0
0 80 160 240 320 400 480 560 640
Gate Charge (nC)

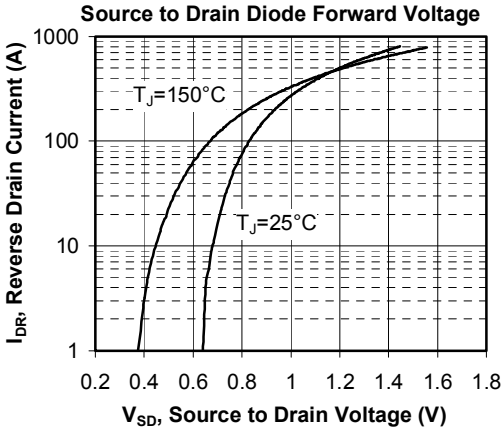












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